

IS471F

OPIC Light Detector with Built-in Signal Processing Circuit for Light Modulation System

■ Features

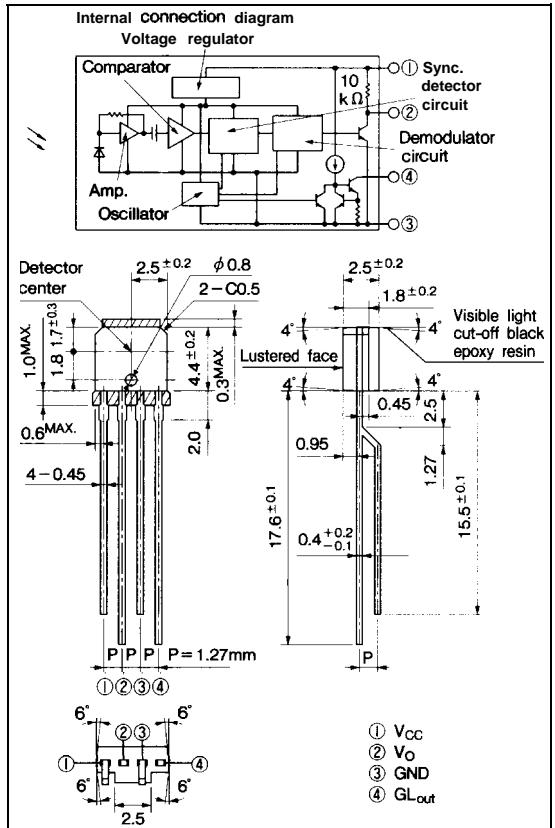
1. Impervious to external disturbing lights due to light modulation system
 2. Built-in pulse driver circuit and sync. detector circuit on the emitter side
 3. A wide range of operating supply voltage (V_{CC} : 4.5 to 16V)

■ Applications

1. Optoelectronic switches
 2. Copiers, printers
 3. Facsimiles

■ Outline Dimensions

(Unit : mm)

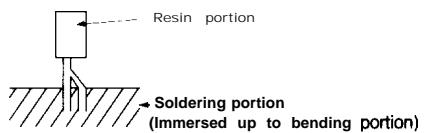


* "OPIC" (Optical IC) is a trademark of the SHARP corporation.
An OPIC consists of a light-detecting element and signal-processing circuit integrated onto a single chip.

Absolute Maximum Ratings

(Ta = 25°C)

Parameter		Symbol	Rating	Unit
Supply voltage		V _{CC}	-0.5 to 16	v
output	Output voltage	V _O	16	v
	Output current	I _O	50	mA
* ¹ GL output	Output voltage	V _{GL}	16	V
Power dissipation		P	250	mW
Operating temperature		T _{opr}	-25 to +60	°c
Storage temperature		T _{stg}	-40 to +100	°C
*Soldering temperature		T _{sol}	260	°C



*1 Applies to GL_{out} terminal

*2 For 5 seconds at the position shown in the right figure

■ Electro-optical Characteristics

(V_{CC}=5V, Ta=25°C)

Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Operating supply voltage	V _{CC}		4.5	—	16	v
Supply current	I _{CC}	V _O , G _{Lout} terminals shall be opened.	—	3.5	7.0	mA
output	Low level output voltage	V _{OL}	I _{OL} =16mA, E _{VP} =500lx, E _{VD} =0 ^{*3}	—	0.15	0.35
	High level output voltage	V _{OH}	E _{VD} =E _{VP} =0 ^{*3}	4.97	—	v
	Output short circuit current	I _{OS}	E _{VP} =E _{VD} =0 ^{*3}	0.25	0.5	1.0
GL output	Low level output current	I _{GL}	V _{GL} =1.2V	40	55	mA
	*4Pulse cycle	t _p		70	130	μs
	*4Pulse width	t _w		4.4	8	13.7
*5 "Low→High" threshold irradiance	E _{ePLH}	E _{eD} =0 ^{*3}	—	0.4	2.66	μW/mm ²
*5 "High→Low" threshold irradiance	E _{ePHL}	Light emitting diode ($\lambda_p=940\text{nm}$) ^{*6}	—	0.7	2.8	μW/mm ²
Hysteresis	E _{ePLH} /E _{ePHL}		0.45	0.65	0.95	—
Response time	High→Low propagation delay time	t _{PHL}	*6	—	400	670
	Low→High propagation delay time	t _{PLH}	*6	—	400	670
*7External disturbing light illuminance	E _{VDX}	E _{eP} =7.5 μW/mm ² , ^{*3} λ _p =940nm	2000	4500	—	lx

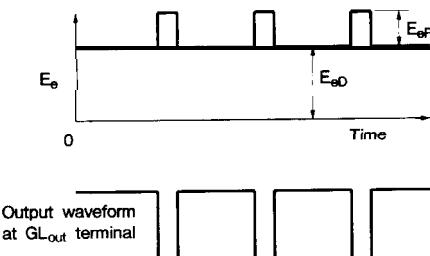
*3 E_{eP} represents illuminance of signal light in sync with the low level timing of output at GL_{out} terminal.

E_{eD} represents illuminance of DC light. For detail, see Fig. 1.

Light source : Infrared light emitting diode ($\lambda_p=940\text{nm}$)

E_{VP} represents illuminance of signal light in sync with the low level timing of output at GL_{out} terminal.

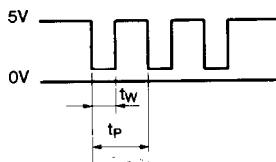
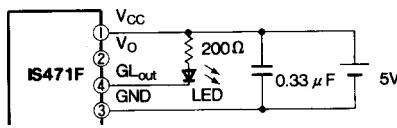
E_{VD} represents illuminance of DC light. Note that the light source is CIE standard light source A.

Fig.1

(Note) Fig. 1 shows the output waveform at GL_{out} terminal with IS471 F connected as shown in Fig. 3.

*4 Pulse cycle (t_p), pulse width (t_w) are defined as shown in Fig. 2.

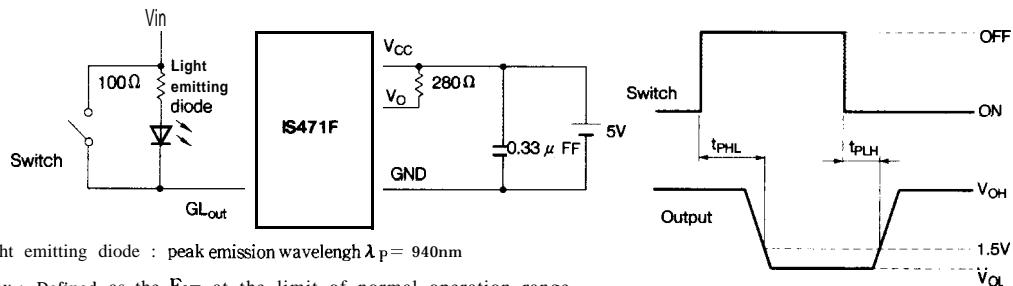
The waveform shown in Fig. 2 is the output voltage waveform at GL_{out} terminal with IS471 F connected as shown in Fig. 3

Fig.2**Fig.3**

*5 Defined as E_{eP} that causes the output to go "Low to High" (or "High to Low")

*6 Test circuit for response time, threshold irradiance is shown in Fig. 4.

Fig. 4



*7 Evox : Defined as the E_{VD} at the limit of normal operation range.

Fig. 5 Power Dissipation vs. Ambient Temperature

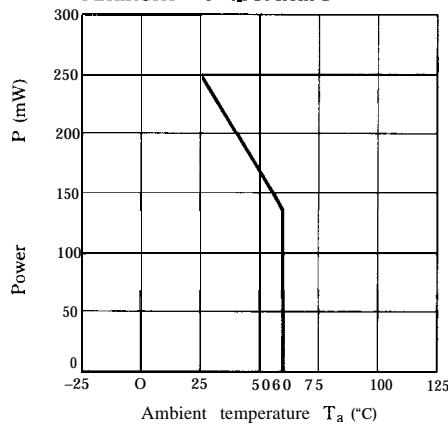


Fig. 6 Low Level Output Voltage vs. Low Level Output Current

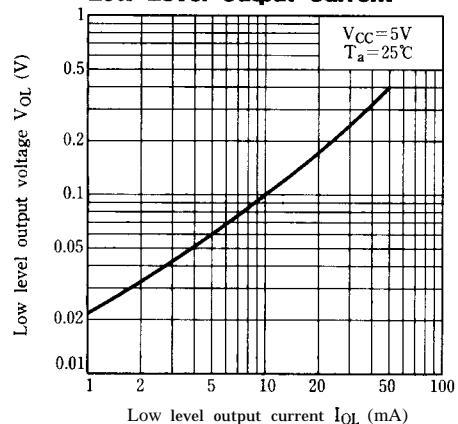


Fig. 7 Low Level Output Voltage vs. Ambient Temperature

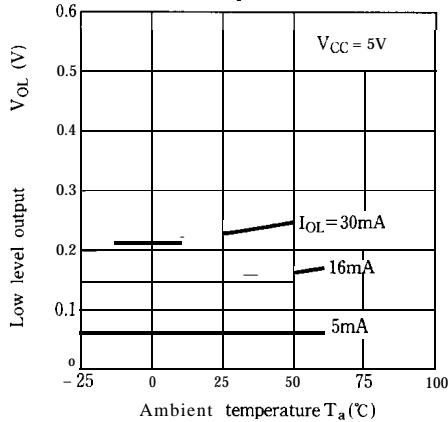


Fig. 8 Supply Current vs. Supply Voltage

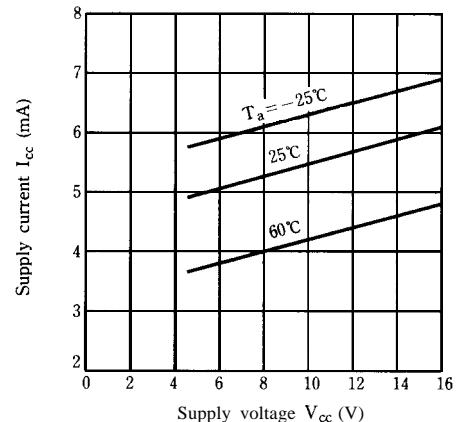


Fig. 9 Low Level Output Current vs. Supply Voltage

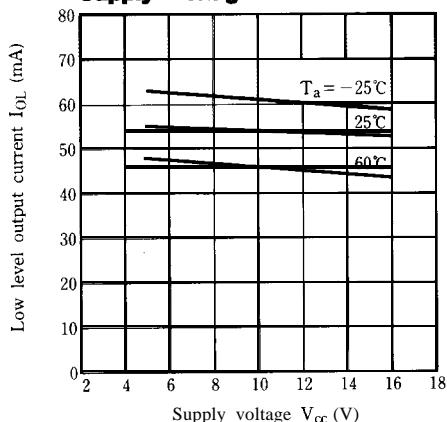
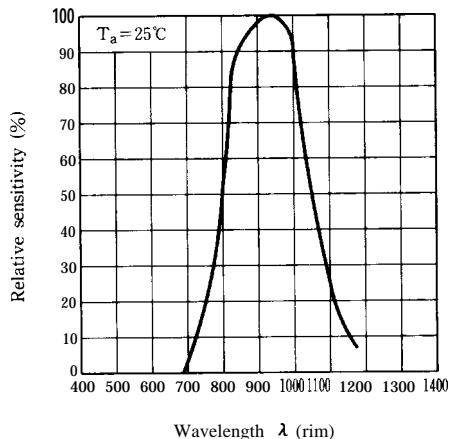
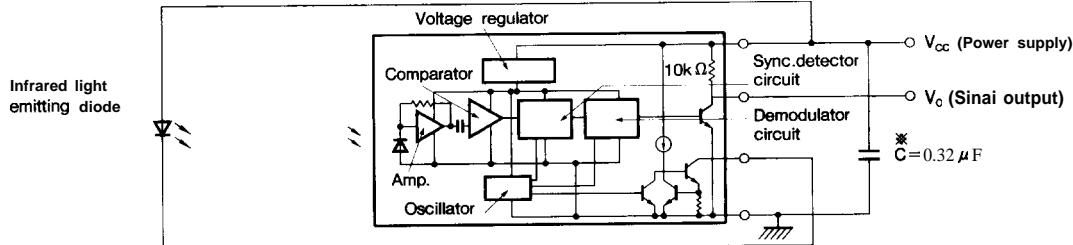


Fig.11 Spectral Sensitivity



■ Basic * *



* In order to stabilize power supply line, connect a by-pass capacitor of $0.33 \mu\text{F}$ or more between V_{cc} and GND near the device.

Please refer to the chapter "Precautions for Use." (Page 78 to 93)

Fig.10 Sensitivity Diagram ($T_a=25^\circ\text{C}$)

